

December 2009

# FSUSB104 — Low-Power, Two-Port, Hi-Speed, USB2.0 (480Mbps) Switch

#### **Features**

- Low On Capacitance: 3.7pF Typical
  Low On Resistance: 3.9Ω Typical
- Low Power Consumption: 1µA Maximum
  - 15μA Maximum I<sub>CCT</sub> over an Expanded Voltage Range (V<sub>IN</sub>=1.8V, V<sub>CC</sub>=4.3V)
- Wide -3db Bandwidth: > 720MHz
- Packaged in Pb-free 10-Lead UMLP (1.4 x 1.8mm)
- 8kV ESD Rating, >16kV Power/GND ESD Rating
- Power-Off Protection on All Ports When V<sub>CC</sub>=0V
  - D+/D- Pins Tolerate up to 5.25V

### **Applications**

- Cell phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-Top Box

#### **IMPORTANT NOTE:**

For additional performance information, please contact analogswitch@fairchildsemi.com.

# **Description**

The FSUSB104 is a bi-directional, low-power, two-port, Hi-Speed, USB2.0 switch. Configured as a double-pole, double-throw switch (DPDT) switch, it is optimized for switching between two Hi-Speed (480Mbps) sources or a Hi-Speed and Full-Speed (12Mbps) source.

The FSUSB104 is compatible with the requirements of USB2.0 and features an extremely low on capacitance  $(C_{ON})$  of 3.7pF. The wide bandwidth of this device (720MHz) exceeds the bandwidth needed to pass the third harmonic, resulting in signals with minimum edge and phase distortion. Superior channel-to-channel crosstalk also minimizes interference.

The FSUSB104 contains special circuitry on the switch I/O pins for applications where the  $V_{\text{CC}}$  supply is powered-off ( $V_{\text{CC}}\!=\!0$ ), which allows the device to withstand an over-voltage condition. This device is designed to minimize current consumption even when the control voltage applied to the SEL pin is lower than the supply voltage ( $V_{\text{CC}}$ ). This feature is especially valuable to ultra-portable applications, such as cell phones, allowing for direct interface with the general-purpose I/Os of the baseband processor. Other applications include switching and connector sharing in portable cell phones, PDAs, digital cameras, printers, and notebook computers.

# **Ordering Information**

Part Number	Top Mark	Operating Temperature Range	© Eco Status	Package
FSUSB104UMX	JF	-40 to +85°C	Green	10-Lead, Quad, Ultrathin Molded Leadless Package (UMLP), 1.4 x 1.8mm

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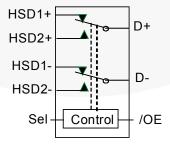


Figure 1. Analog Symbol

# **Pin Assignments**

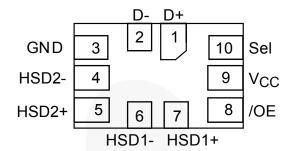


Figure 2. FSUSB104 Pin Assignment 10L UMLP (Top Through View)

# **Pin Definitions**

Pin #	Name	Description
1	D+	USB Data Bus
2	D-	USB Data Bus
3	GND	Ground
4	HSD2-	Multiplexed Source inputs
5	HSD2+	Multiplexed Source inputs
6	HSD1-	Multiplexed Source inputs
7	HSD1+	Multiplexed Source inputs
8	/OE	Switch Enable
9	V <sub>CC</sub>	Supply Voltage
10	Sel	Switch Select

# **Truth Table**

Sel	/OE	Function
X	HIGH	Disconnect
LOW	LOW	D+, D-=HSD1+, HSD1-
HIGH	LOW	D+, D-=HSD2+, HSD2-

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
Vcc	Supply Voltage		-0.5	+5.5	V
V <sub>CNTRL</sub>	DC Input Voltage (S, /OE) <sup>(1)</sup>		-0.5	V <sub>CC</sub>	V
V <sub>SW</sub>	DC Switch I/O Voltage <sup>(1)</sup>		-0.5	V <sub>CC</sub> + 0.3	V
I <sub>IK</sub>	DC Input Diode Current		-50		mA
lout	DC Output Current			50	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
		All Pins		7	
ESD	Human Body Model, JEDEC: JESD22-A114	I/O to GND		8	kV
ESD		Power to GND		16	٨V
	Charged Device Model, JEDEC: JESD22-C10	)1		2	

#### Note:

 The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Unit
V <sub>CC</sub>	Supply Voltage	3.0	4.3	V
V <sub>CNTRL</sub>	Control Input Voltage (S, /OE) (2)	0	Vcc	V
V <sub>SW</sub>	Switch I/O Voltage	-0.5	4.5	V
T <sub>A</sub>	Operating Temperature	-40	+85	°C

#### Note:

2. The control input must be held HIGH or LOW and it must not float.

# **DC Electrical Characteristics**

All typical value are at 25°C unless otherwise specified.

0	Donous et an	O an dition o	V 00	T <sub>A</sub> =- 40°C to +85°C			l luite
Symbol	Parameter	Conditions	V <sub>cc</sub> (V)	Min.	Тур.	Max.	Units
V <sub>IK</sub>	Clamp Diode Voltage	I <sub>IN</sub> =-18mA	3.0			-1.2	V
	land Walter and High		3.0 to 3.6	1.3			V
$V_{IH}$	Input Voltage High		4.3	1.7			V
	land Maltana I am		3.0 to 3.6			0.5	V
$V_{IL}$	Input Voltage Low		4.3			0.7	V
I <sub>IN</sub>	Control Input Leakage	V <sub>SW</sub> =0 to V <sub>CC</sub>	4.3	-1		1	μA
l <sub>OZ</sub>	Off State Leakage	0 ≤ Dn, HSD1n, HSD2n ≤ 3.6V	4.3	-2		2	μA
I <sub>OFF</sub>	Power-Off Leakage Current (All I/O Ports)	V <sub>SW</sub> =0V to 4.3V, V <sub>CC</sub> =0V Figure 4	0	-2		2	μA
Ron	HS Switch On Resistance <sup>(3)</sup>	V <sub>SW</sub> =0.4V, I <sub>ON</sub> =-8mA Figure 3,	3.0		3.9	6.5	Ω
$\Delta R_{ON}$	HS Delta Ron <sup>(4)</sup>	V <sub>SW</sub> =0.4V, I <sub>ON</sub> =-8mA	3.0		0.65		Ω
Icc	Quiescent Supply Current	V <sub>CNTRL</sub> =0 or V <sub>CC</sub> , I <sub>OUT</sub> =0	4.3			1.0	μA
	Increase in I <sub>CC</sub> Current per	V <sub>CNTRL</sub> =2.6V, V <sub>CC</sub> =4.3V	4.3			10.0	μA
I <sub>CCT</sub>	Control Voltage and V <sub>CC</sub>	V <sub>CNTRL</sub> =1.8V, V <sub>CC</sub> =4.3V	4.3			15.0	μA

- Measured by the voltage drop between HSDn and Dn pins at the indicated current through the switch. On resistance is determined by the lower of the voltage on the two (HSDn or Dn ports). Guaranteed by characterization.

# **AC Electrical Characteristics**

All typical value are for  $V_{\text{CC}}$ =3.3V at 25°C unless otherwise specified.

Symbol	Doromotor	Conditions	V (V)	T <sub>A</sub> =- 40°C to +85°C			Units
Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	Min.	Тур.	Max.	Ullits
ton	Turn-On Time S, /OE to Output	$R_L$ =50 $\Omega$ , $C_L$ =5pF $V_{SW}$ =0.8V Figure 5, Figure 6	3.0 to 3.6		13	30	ns
toff	Turn-Off Time S, /OE to Output	$R_L$ =50 $\Omega$ , $C_L$ =5pF $V_{SW}$ =0.8V Figure 5, Figure 6	3.0 to 3.6		12	25	ns
t <sub>PD</sub>	Propagation Delay <sup>(5)</sup>	$C_L$ =5 pF, $R_L$ =50 $\Omega$ Figure 5, Figure 7	3.3		0.25		ns
t <sub>BBM</sub>	Break-Before-Make	$R_L$ =50 $\Omega$ , $C_L$ =5pF $V_{SW1}$ = $V_{SW2}$ =0.8V Figure 9	3.0 to 3.6	2.0		6.5	ns
O <sub>IRR</sub>	Off Isolation	R <sub>L</sub> =50Ω, f=240MHz Figure 11	3.0 to 3.6		-30		dB
Xtalk	Non-Adjacent Channel Crosstalk	R <sub>L</sub> =50Ω, f=240MHz Figure 12	3.0 to 3.6		-45		dB
BW	-3db Bandwidth	$R_L$ =50 $\Omega$ , $C_L$ =0pF Figure 10	204-20		720		MHz
DVV	-oub Bandwidth	$R_L$ =50 $\Omega$ , $C_L$ =5pF Figure 10	3.0 to 3.6		550		MHz

#### Note:

# **USB Hi-Speed-Related AC Electrical Characteristics**

Cumbal	Dougnoston Conditions		Vac (V)	T <sub>A</sub> =- 4	40ºC to	+85°C	Unito
Symbol	Parameter	Conditions	Vcc (V)	Min.	Тур.	Max.	Units
t <sub>SK(P)</sub>	Skew of Opposite Transitions of the Same Output <sup>(6)</sup>	$C_L$ =5pF, $R_L$ =50 $\Omega$ Figure 8	3.0 to 3.6	7	20		ps
t∪	Total Jitter <sup>(6)</sup>	$R_L$ =50 $\Omega$ , $C_L$ =5pf, $t_R$ = $t_F$ =500ps (10-90%) at 480Mbps (PRBS= $2^{15}$ – 1)	3.0 to 3.6		200		ps

#### Note:

# Capacitance

Cumbal	Davamatar	Conditions	T <sub>A</sub> =- 40°C to +85°C			Unite
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Units
C <sub>IN</sub>	Control Pin Input Capacitance	V <sub>CC</sub> =0V		1.5		
C <sub>ON</sub>	D+/D- On Capacitance	V <sub>CC</sub> =3.3V, /OE=0V, f=240MHz Figure 14		3.7		pF
C <sub>OFF</sub>	D1n, D2n Off Capacitance	V <sub>CC</sub> and /OE=3.3V See Figure 13		2.0		

<sup>5.</sup> Guaranteed by characterization.

<sup>6.</sup> Guaranteed by characterization.

# **Test Diagrams**

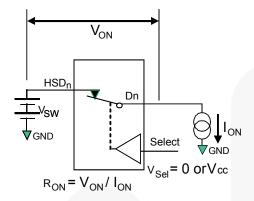
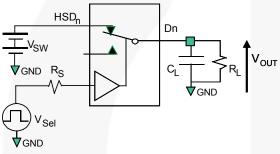
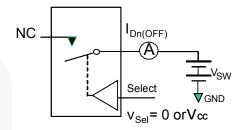


Figure 3. On Resistance



 $R_L$ ,  $R_S$ , and  $C_L$  are functions of the application environment (see AC Tables for specific values)  $C_L$  includes test fixture and stray capacitance.

Figure 5. AC Test Circuit Load



\*\*Each switch port is tested separately

Figure 4. Off Leakage

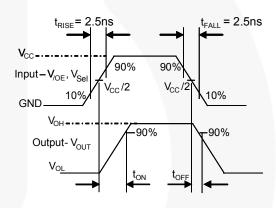
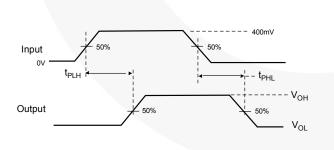
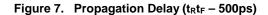


Figure 6. Turn-On / Turn-Off Waveforms





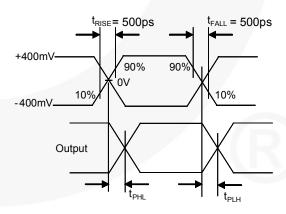


Figure 8. Intra-Pair Skew Test t<sub>SK(P)</sub>

# 

Figure 9. Break-Before-Make Interval Timing

C, includes test fixture and stray capacitance.

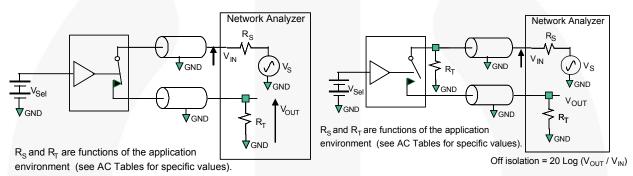


Figure 10. Bandwidth

Figure 11. Channel Off Isolation

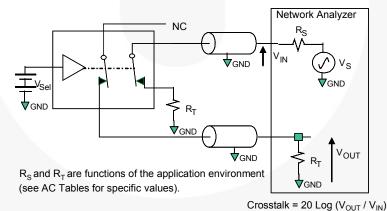


Figure 12. Non-Adjacent Channel-to-Channel Crosstalk

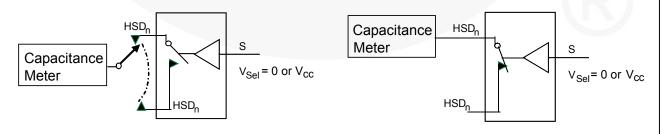
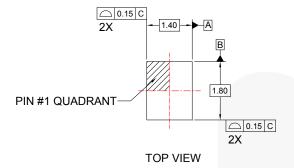
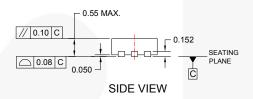


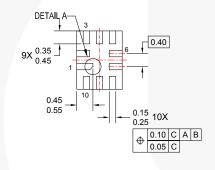
Figure 13. Channel Off Capacitance

Figure 14. Channel On Capacitance

# **Physical Dimensions**



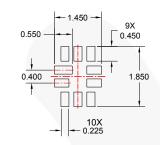




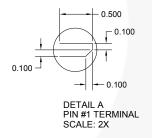
**BOTTOM VIEW** 

# 0.663 9X 0.563 0.563 0.400 0.400 0.400 0.400

RECOMMENDED LAND PATTERN



OPTIONAL MINIMIAL TOE LAND PATTERN



#### NOTES:

- A. DIMENSIONS ARE IN MILLIMETERS.
- B. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994
- C. DRAWING FILENAME: UMLP10Arev2

# Figure 15. 10-Lead, Ultrathin Molded Leadless Package (UMLP)

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